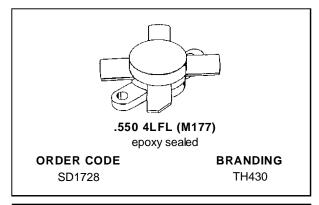
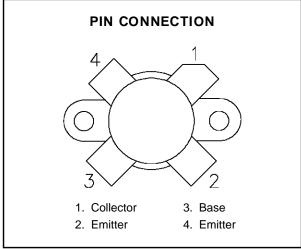


SD1728 (TH430)

RF & MICROWAVE TRANSISTORS HF SSB APPLICATIONS

- OPTIMIZED FOR SSB
- 30 MHz
- 50 VOLTS
- IMD 30 dB
- GOLD METALLIZATION
- COMMON EMITTER
- Pout = 250 W PEP WITH 14.5 dB GAIN





DESCRIPTION

The SD1728 is a 50 V epitaxial silicon NPN planar transistor designed primarily for SSB and VHF communications. This device utilizes emitter ballasting for improved ruggedness and reliability.

ABSOLUTE MAXIMUM RATINGS $(T_{case} = 25^{\circ}C)$

Symbol	Parameter	Value	Unit	
V _{CBO}	Collector-Base Voltage	110	V	
V _{CEO}	Collector-Emitter Voltage	55	V	
V _{EBO}	Emitter-Base Voltage	4.0	V	
Ic	Device Current	40	А	
Poiss	Power Dissipation	330	W	
TJ	Junction Temperature	+200	°C	
T _{STG}	Storage Temperature	– 65 to +150	°C	

THERMAL DATA

D=	Junatian Casa Thormal Pagistones	0.4	°C/\\\
RTH(j-c)	Junction-Case Thermal Resistance	0.4	- C/ VV

November 1992 1/9

SD1728 (TH430)

ELECTRICAL SPECIFICATIONS (Tcase = 25°C)

STATIC

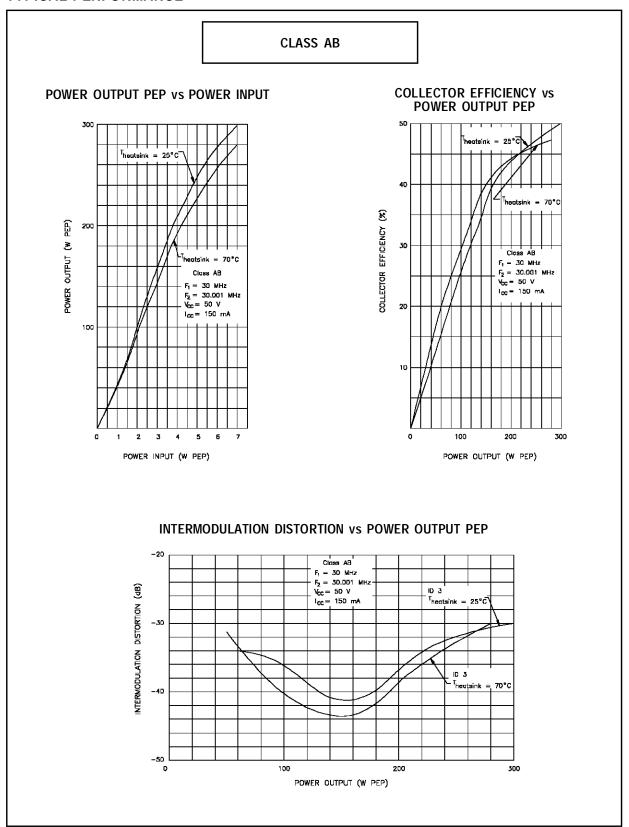
Symbol	Test Conditions	Value			Unit		
		Min.	Тур.	Max.	Oiiit		
BVces	I _C = 200mA	$V_{BE} = 0V$		110	_	_	V
BV _{CEO}	I _C = 200mA	$I_B = 0mA$		55	_	_	V
BV _{EBO}	I _E = 20mA	$I_C = 0mA$		4.0	_	_	V
I _{CEO}	V _{CE} = 30V	$I_{E} = 0mA$		_	_	10	mA
Ices	Vce = 60V	I _E = 0mA		_	_	10	mA
hFE	Vce = 6V	I _C = 10A		15	_	45	_

DYNAMIC

Symbol	Test Conditions		Value			Unit	
	rest Conditions			Min.	Тур.	Max.	
Роит	f = 30 MHz	V _C C = 50 V	$I_{CQ} = 150 \text{ mA}$	250	_	_	W
G _P *	Pout = 250 W PEP	$V_{CC} = 50 V$	$I_{CQ} = 150 \text{ mA}$	14.5	_	_	dB
IMD*	Pout = 250 W PEP	$V_{CC} = 50 V$	$I_{CQ} = 150 \text{ mA}$	_	_	-30	dBc
η _C *	P _{OUT} = 250 W PEP	$V_{CC} = 50 \text{ V}$	$I_{CQ} = 150 \text{ mA}$	37	_		%
Сов	f = 1 MHz	$V_{CB} = 50 V$		_	_	360	pF

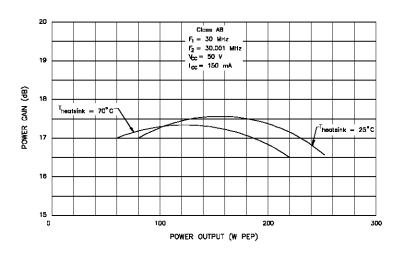
Note: * Two Tone Method; f $_1$ = 30.00 MHz; f $_2$ = 30.001 MHz In Class C: G $_P$ Min. 13.5 dB, Efficiency 65%@ 30MHz G $_P$ Min. 10 dB, Efficiency 57%@ 70MHz

TYPICAL PERFORMANCE

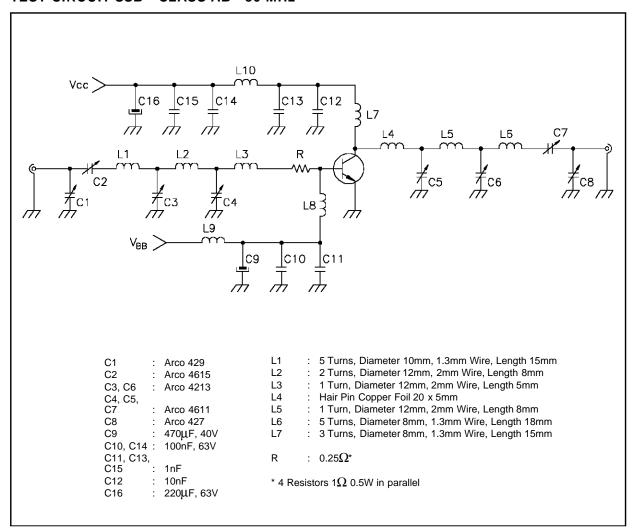


TYPICAL PERFORMANCE (cont'd)

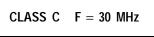
POWER GAIN vs POWER OUTPUT PEP



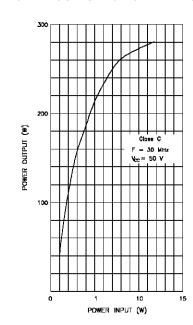
TEST CIRCUIT SSB - CLASS AB - 30 MHz



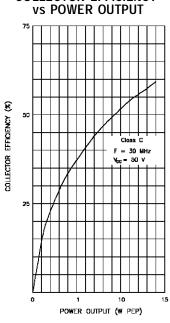
TYPICAL PERFORMANCE



POWER OUTPUT vs POWER INPUT

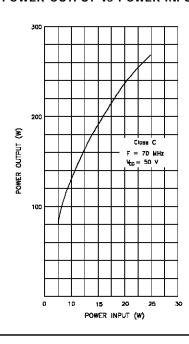


COLLECTOR EFFICIENCY

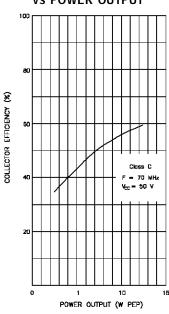


 ${\color{red} CLASS~C~~F=70~MHz} \\$

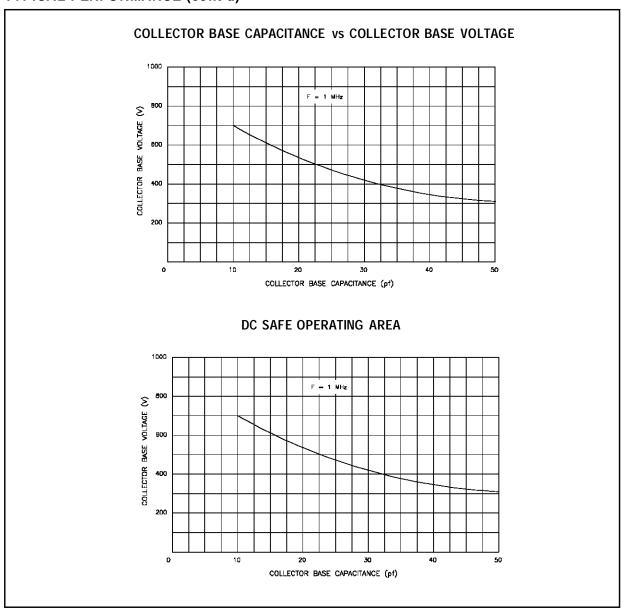
POWER OUTPUT vs POWER INPUT



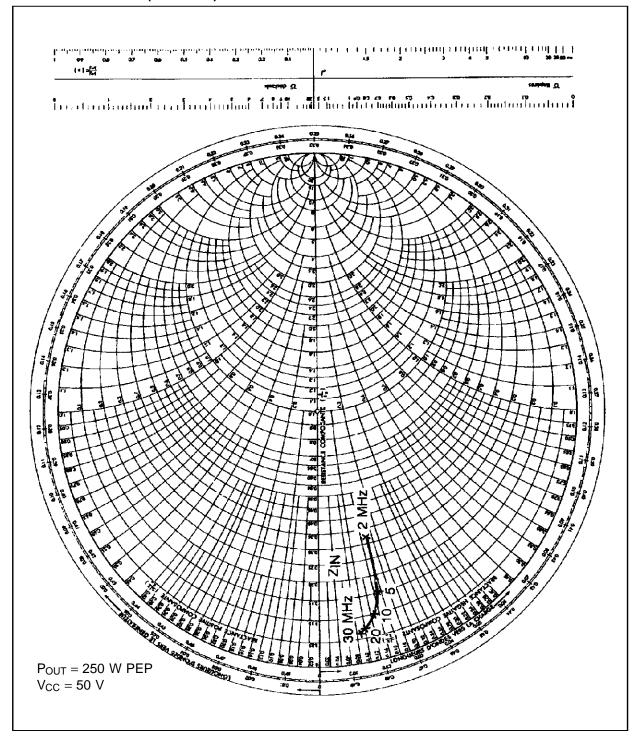
COLLECTOR EFFICIENCY vs POWER OUTPUT



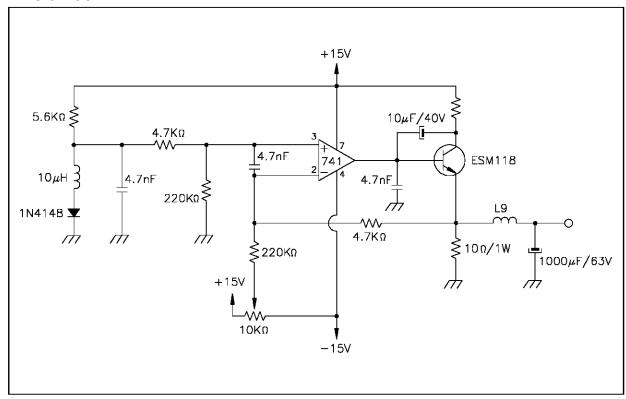
TYPICAL PERFORMANCE (cont'd)



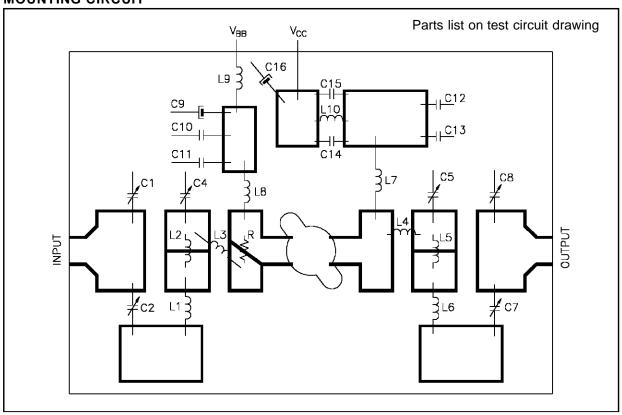
IMPEDANCE DATA (TYPICAL)



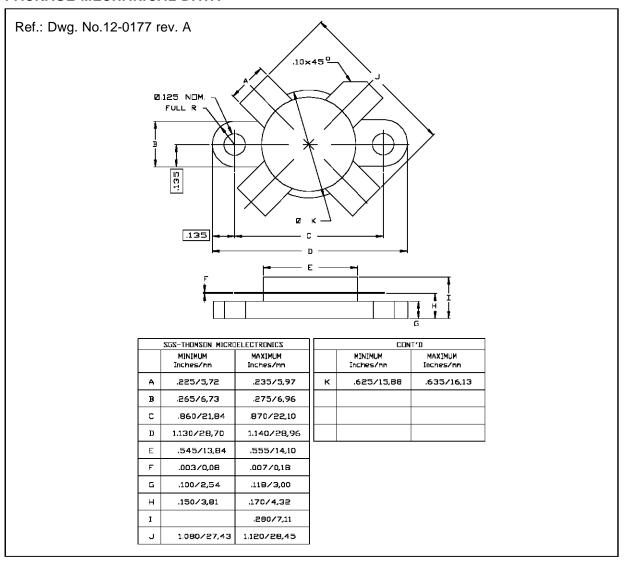
BIAS CIRCUIT



MOUNTING CIRCUIT



PACKAGE MECHANICAL DATA



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